

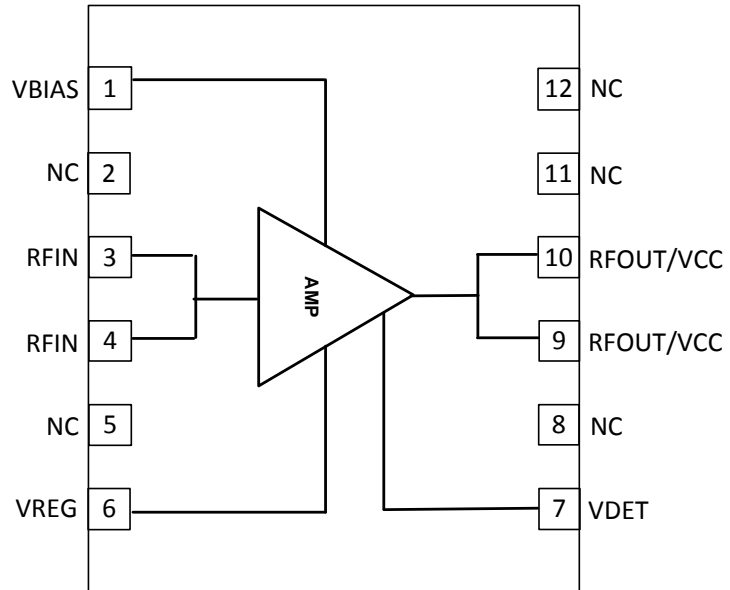


### Features

- WCDMA Power at 2140MHz = 17dBm with -60dBc ACPR
- Gain = 14dB at 2140MHz
- P1dB = 30dBm at 2140MHz
- Externally Matched
- Power-down Capability
- Class 1C HBM ESD Rating
- On-chip Input Power Detector

### Applications

- 2G, 3G, and 4G Air Interfaces
- Driver Amplifier for Commercial Wireless Infrastructure
- Picocell, Femtocell Power Amplifier
- WCDMA, LTE, TD-SCDMA, GSM



Functional Block Diagram

### Product Description

The RFPA2224 is a single-stage InGaP HBT power amplifier. It exhibits excellent back-off characteristics making it ideal for ultra-linear driver amplifier applications. The RFPA2224 can also be optimized for use as a small-cell PA output stage. External matching and bias control allows the RFPA2224 to be used across various radio platforms within 700MHz to 2700MHz. The PA2224 offers a robust Class 1C (>1000V) HBM ESD rating in a compact 4mm x 5mm DFN package.

### Ordering Information

RFPA2224SR	7" Reel with 100 pieces
RFPA2224SQ	Sample bag with 25 pieces
RFPA2224TR13	13" Reel with 2500 pieces
RFPA2224PCK-410	728MHz to 768MHz PCBA with 5-piece sample bag
RFPA2224PCK-411	2110MHz to 2170MHz PCBA with 5-piece sample bag
RFPA2224PCK-412	2580MHz to 2690MHz PCBA with 5-piece sample bag

## Absolute Maximum Ratings

Parameter	Rating	Unit
Supply Voltage ( $V_{CC}$ , $V_{BIAS}$ )	7.0	V
Collector Current ( $I_C$ )	750	mA
CW Input Power, 50Ω	30	dBm
Modulated (WCDMA) Input Power, 6:1 Output VSWR	14	dBm
Operating Junction Temperature	165	°C
Operating Temperature Range ( $T_L$ )	-40 to +85	°C
Storage Temperature	-40 to +150	°C
ESD Rating - Human Body Model (HBM)	Class 1C	
Moisture Sensitivity Level	MSL 1	



**Caution!** ESD sensitive device.

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device. Extended application of Absolute Maximum Rating conditions to the device may reduce device reliability. Specified typical performance or functional operation of the device under Absolute Maximum Rating conditions is not implied.

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RFMD Green: RoHS compliant per EU Directive 2002/95/EC, halogen free per IEC 61249-2-21, < 1000ppm each of antimony trioxide in polymeric materials and red phosphorus as a flame retardant, and <2% antimony in solder.

Notes:

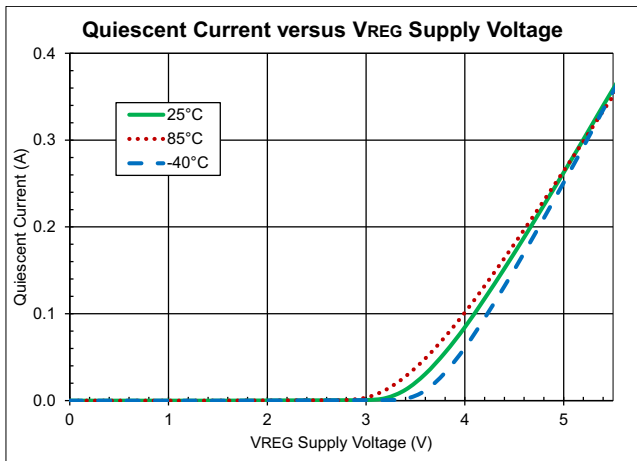
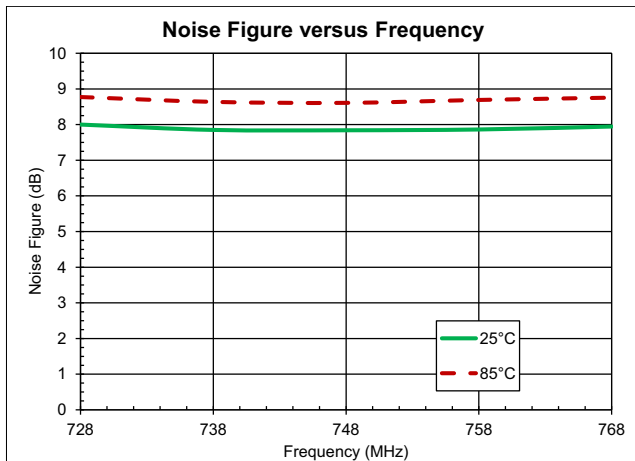
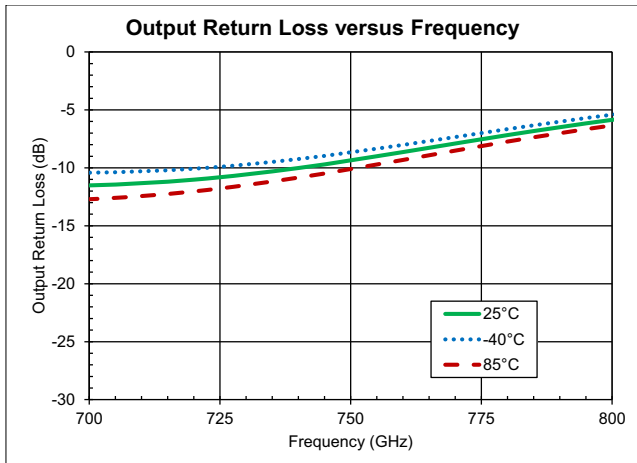
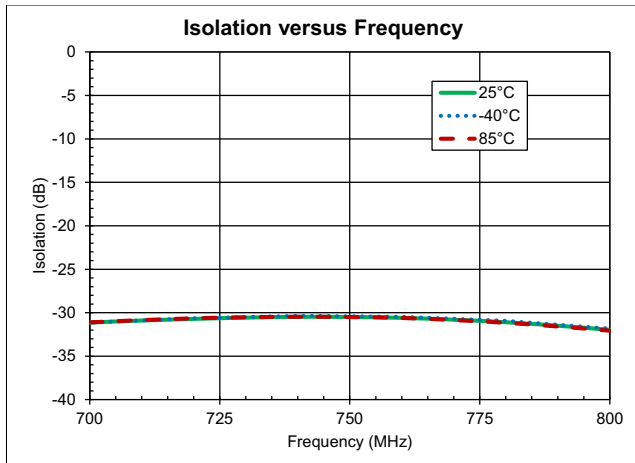
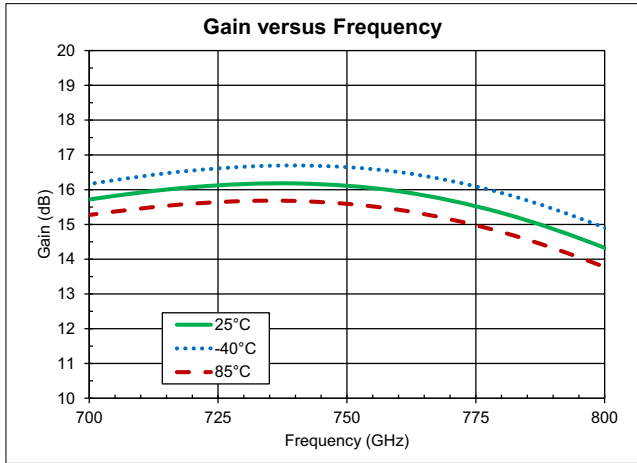
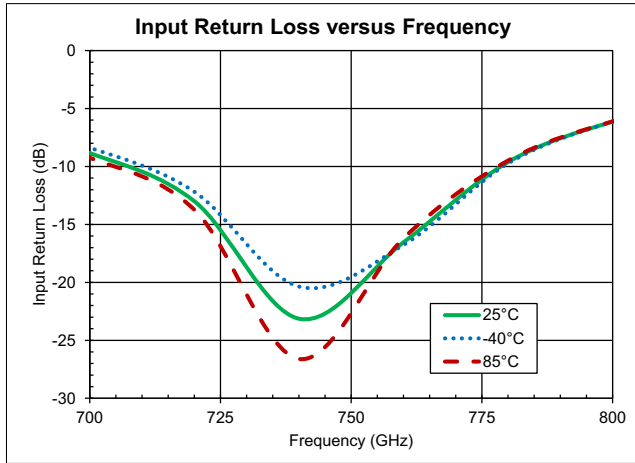
1. The maximum ratings must all be met simultaneously.
2.  $P_{DISS} = P_{DC} + P_{RFIN} - P_{RFOUT}$
3.  $T_J = T_L + P_{DISS} * R_{TH}$

## Nominal Operating Parameters

Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
<b>728MHz to 768MHz</b>					$V_{CC} = 5.0V$ , Temp = 25 °C, Optimized for -60dBc ACPR power
Frequency		748		MHz	
Input Power ( $P_{IN}$ )			11	dBm	Max recommended continuous input power, $V_{CC} = 5.0V$ , Load VSWR = 2:1
Gain (S21)	14.5	16.1	17.5	dB	
ACPR		-60	-55	dBc	RF Output Power = 16 dBm, WCDMA 3GPP 3.5, test model 1, 64 DPCH
OIP3		43		dBm	15 dBm per tone, 1MHz spacing. Optimized for best ACPR.
P1dB		28.8		dBm	
Input Return Loss (S11)		15		dB	
Output Return Loss (S22)		9		dB	
Noise Figure		7.8		dB	
<b>2.11GHz to 2.17GHz</b>					$V_{CC} = 5.0V$ , Temp = 25 °C, Optimized for -60dBc ACPR power
Frequency		2.14		GHz	
Input Power ( $P_{IN}$ )			14	dBm	Max recommended continuous input power, $V_{CC} = 5.0V$ , Load VSWR = 2:1
Gain (S21)	12.5	14.1	15.5	dB	
ACPR		-62	-55	dBc	RF Output Power = 17 dBm, WCDMA 3GPP 3.5, test model 1, 64 DPCH
OIP3		45		dBm	15 dBm per tone, 1MHz spacing. Optimized for best ACPR.
P1dB		29.7		dBm	
Input Return Loss (S11)		18		dB	
Output Return Loss (S22)		11		dB	
Noise Figure		5.3		dB	

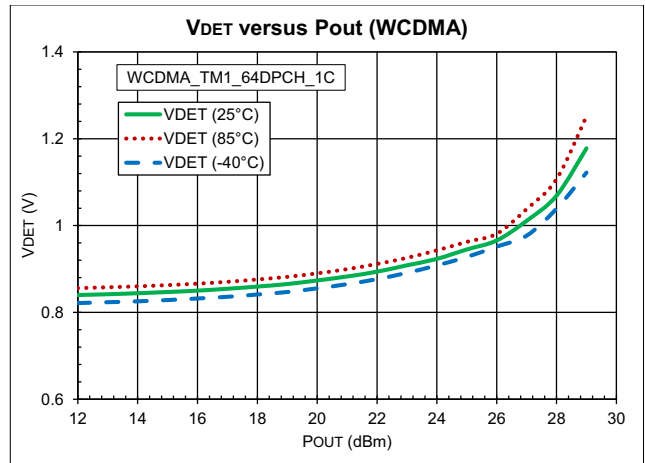
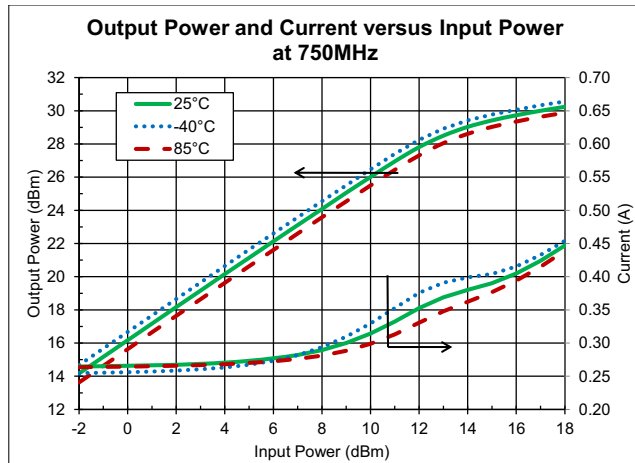
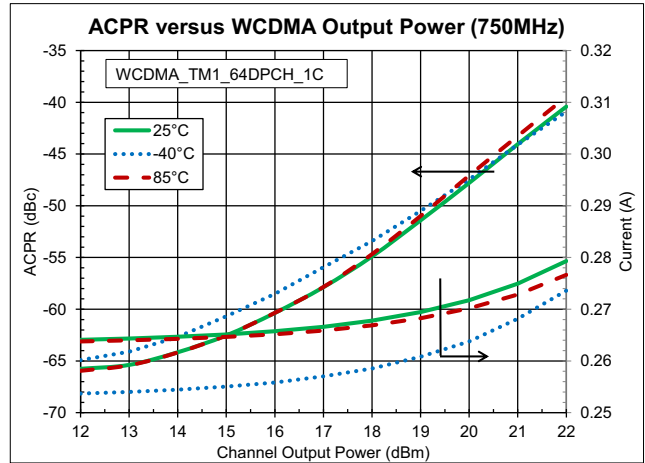
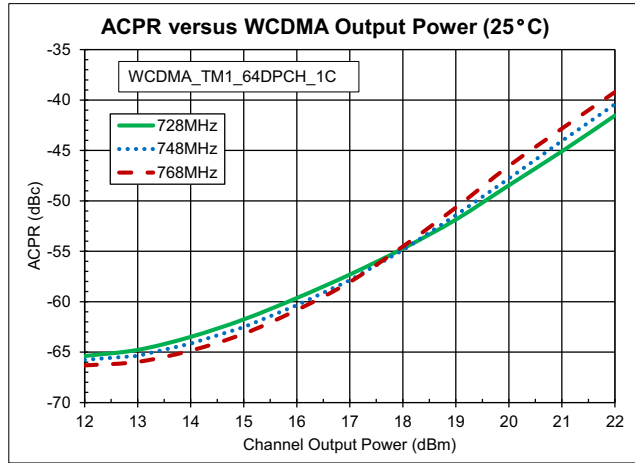
Parameter	Specification			Unit	Condition
	Min.	Typ.	Max.		
<b>2.58GHz to 2.69GHz</b>					$V_{CC} = 5.0V$ , Temp = 25 °C, Optimized for -60dBc ACPR power
Frequency		2.64		GHz	
Input Power ( $P_{IN}$ )			14	dBm	Max recommended continuous input power, $V_{CC} = 5.0V$ , Load VSWR = 2:1
Gain (S21)	11.5	13.1	14.5	dB	
ACPR		-60	-55	dBc	RF Output Power = 17 dBm, WCDMA 3GPP 3.5, test model 1, 64 DPCH
OIP3		43		dBm	15 dBm per tone, 1MHz spacing. Optimized for best ACPR.
P1dB		28.8		dBm	
Input Return Loss (S11)		18		dB	
Output Return Loss (S22)		11		dB	
Noise Figure		5.6		dB	
<b>Power Supply</b>					$V_{CC} = 5.0V$ , Bias Conditions
Quiescent Collector Current	220	265	310	mA	At $V_{CC} = V_{BIAS} = 5.0V$ , Temp = 25 °C
Collector Voltage ( $V_{CC}$ )	4.75	5	5.25	V	
$V_{BIAS}$	4.75	5	5.25	V	At $V_{CC} = V_{BIAS}$ under normal operating conditions
$V_{REG}$	5	5	5	V	Normal operating conditions
Collector Leakage Current (Shutdown)			100	$\mu A$	At $V_{CC} = V_{BIAS} = 5V$ , $V_{REG} = 0V$
Thermal Resistance ( $R_{TH}$ )		24.2		°C/W	Junction-to-back side of package

## Typical Performance: $V_{CC} = V_{BIAS} = V_{REG} = 5V$ 728MHz to 768MHz Application Circuit

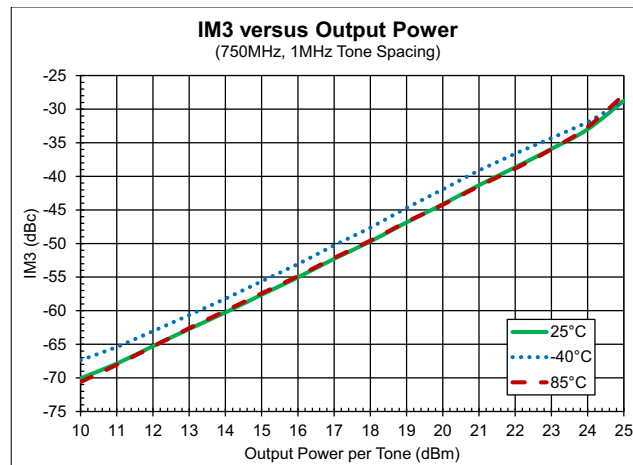
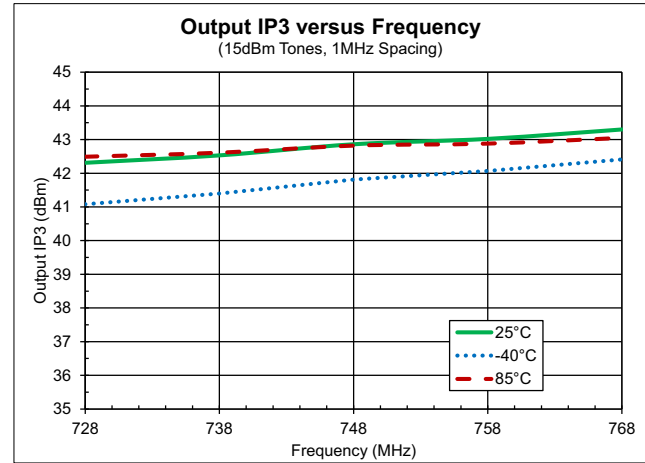
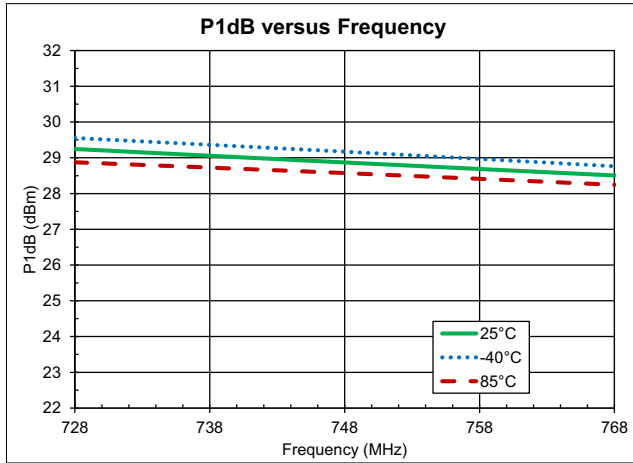


Typical Performance:  $V_{CC} = V_{BIAS} = V_{REG} = 5V$

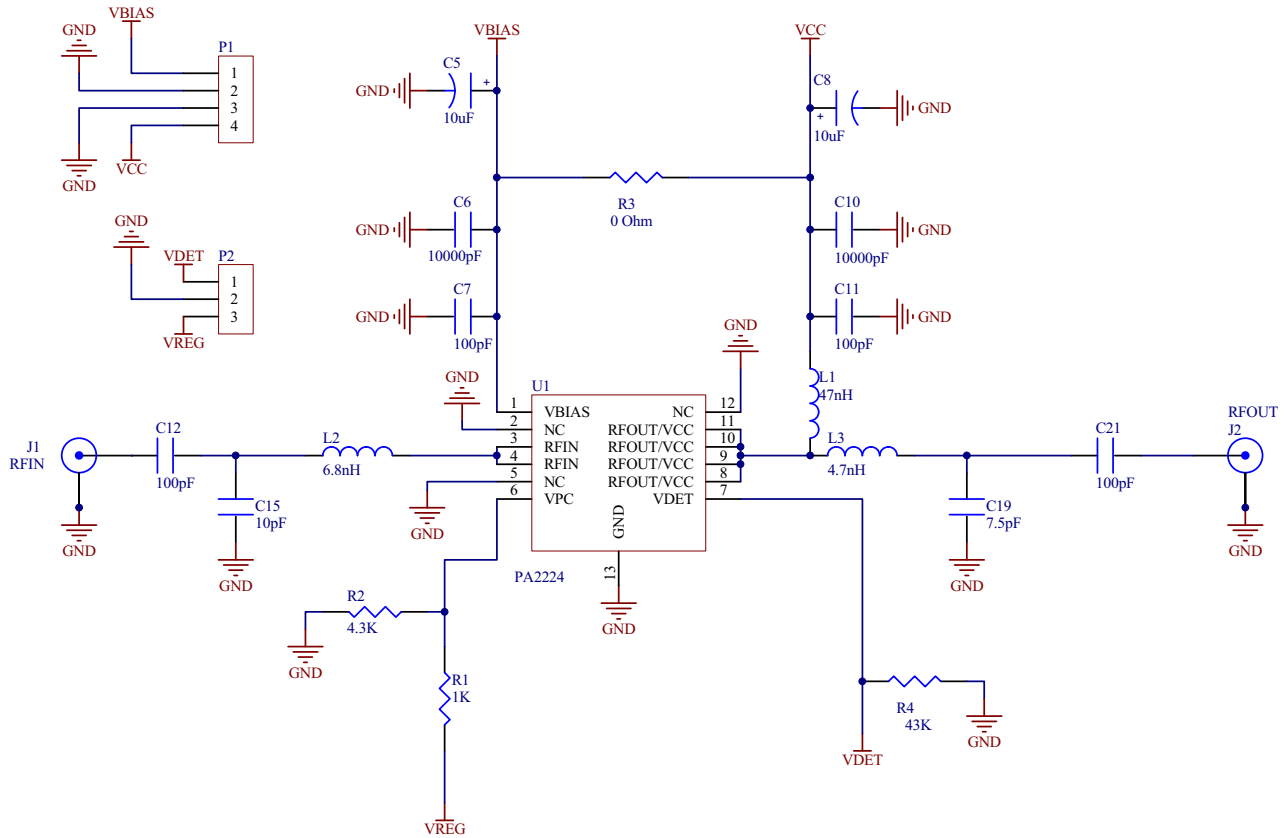
728MHz to 768MHz Application Circuit



## Typical Performance: $V_{CC} = V_{BIAS} = V_{REG} = 5V$ 728MHz to 768MHz Application Circuit



**Evaluation Board Schematic**  
728MHz to 768MHz Application Circuit

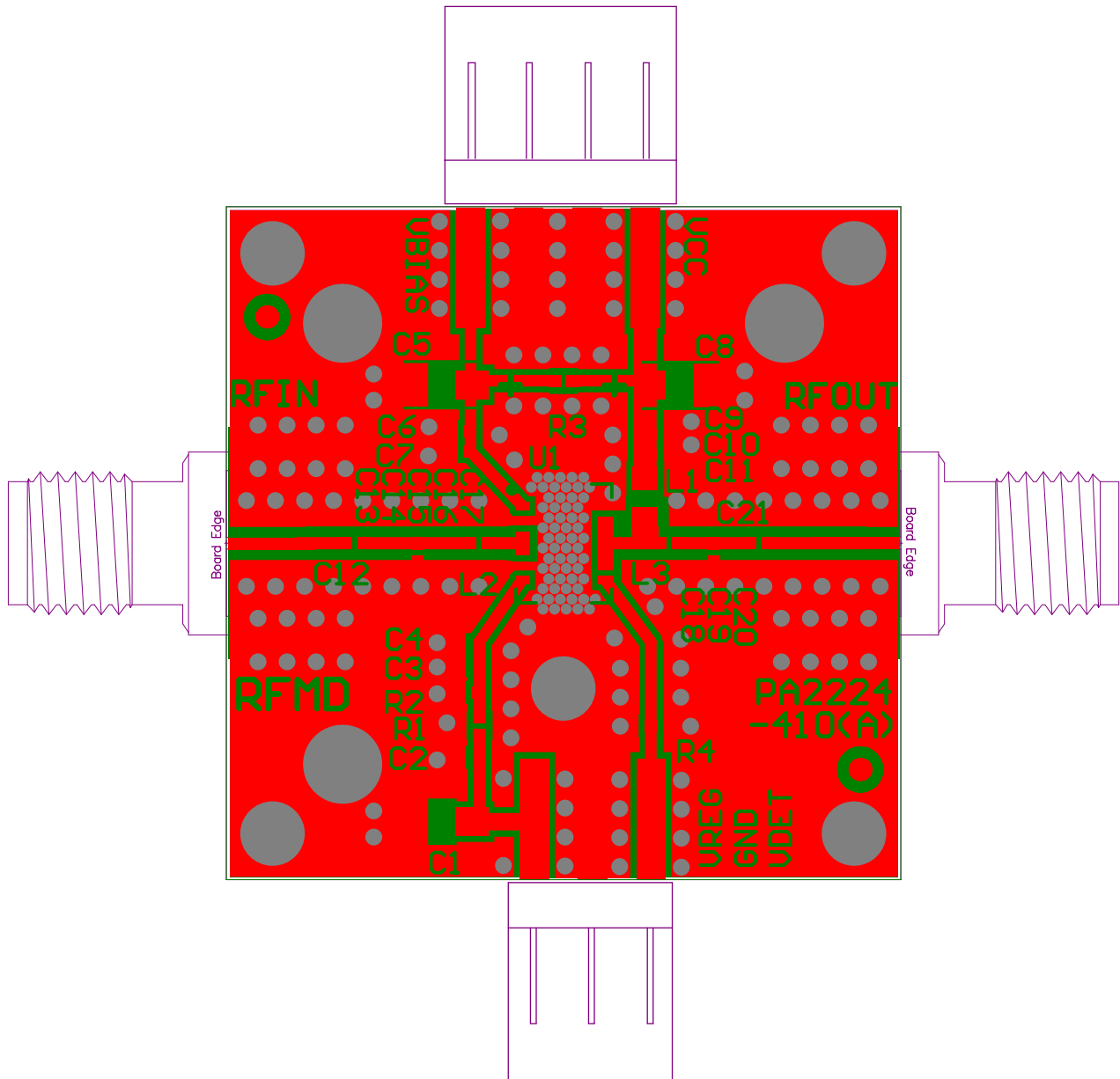


**Evaluation Board Bill of Materials (BOM)**

728MHz to 768MHz Application Circuit

Description	Reference Designator	Manufacturer	Manufacturer's P/N
400MHz to 2700MHz, 1W, 5V High Gain Linear PA	U1	RFMD	PA2224
CAP, 10µF, 10%, 10V, TANT-A	C5, C8	AVX Corporation	TAJA106K010R
CAP, 10000pF, 10%, 16V, X7R, 0402	C6, C10	Taiyo Yuden (USA), Inc.	RM EMK105BJ103KV-F
CAP, 100pF, 5%, 50V, COG, 0402	C7, C11-C12, C21	Murata Electronics	GRM1555C1H101JA01D
CAP, 10pF, 2%, 50V, HI-Q, 0402	C15	Johanson Technology	500R07S100GV4T
CAP, 7.5pF, +/-0.1pF, 50V, HI-Q, 0402	C19	Johanson Technology	500R07S7R5BV4TD
CONN, SMA, END LNCH, RND PIN, 0.039"	J1-J2	Gigalane Co., Ltd.	PSF-S01-002
IND, 47nH, 5%, W/W, 0603	L1	Coilcraft, Inc.	0603HC-47NXJLW
IND, 6.8nH, 5%, W/W, 0402	L2	Coilcraft, Inc.	0402CS-6N8XJL
IND, 4.7nH, 5%, W/W, 0402	L3	Coilcraft, Inc.	0402CS-4N7XJLW
CONN, HDR, ST, PLRZD, 4-PIN, 0.100"	P1	ITW Pancon	MPSS100-4-C
CONN, HDR, ST, PLRZD, 3-PIN, 0.100"	P2	ITW Pancon	MPSS100-3-C
RES, 1K, 5%, 1/16W, 0402	R1	Kamaya, Inc	RMC1/16S-102JTH
4.3K Ω, 5%, 1/16W, 0402, LEAD FREE	R2	KOA Speer Electronics, Inc.	RK73B1ETTP432J
RES, 0Ω, 0402	R3	Kamaya, Inc	RMC1/16SJPTH
RES, 43K, 5%, 1/16W, 0402	R4	Kamaya, Inc	RMC1/16S-433JTH

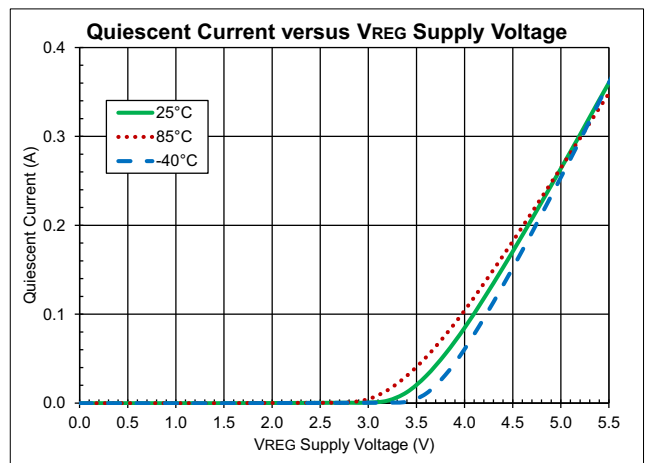
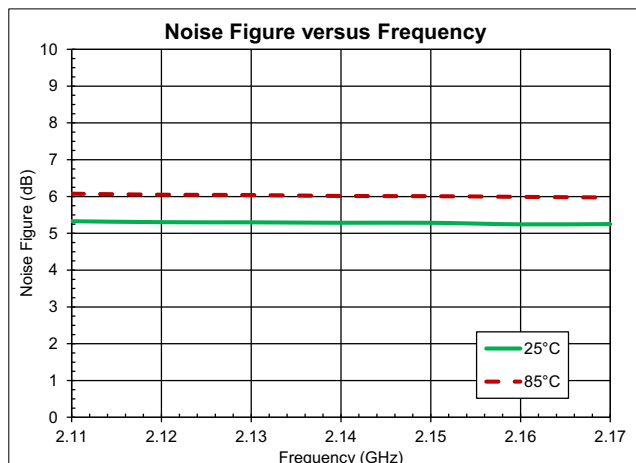
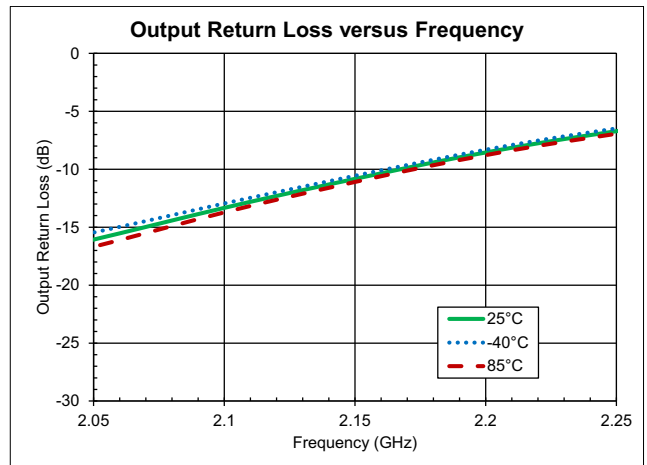
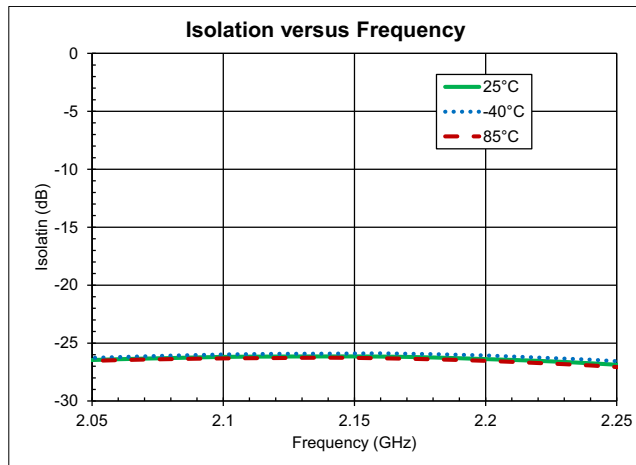
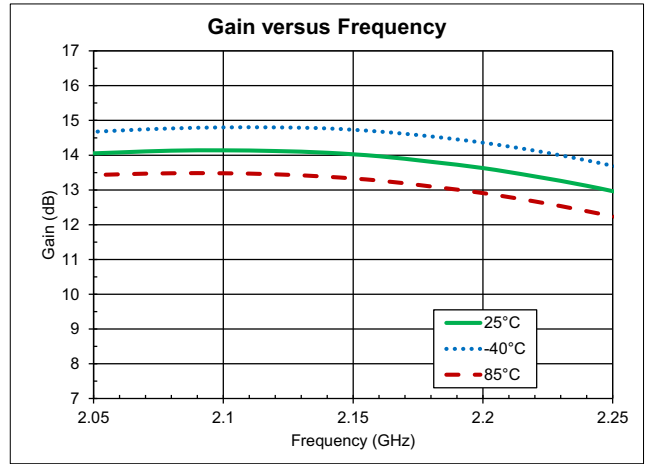
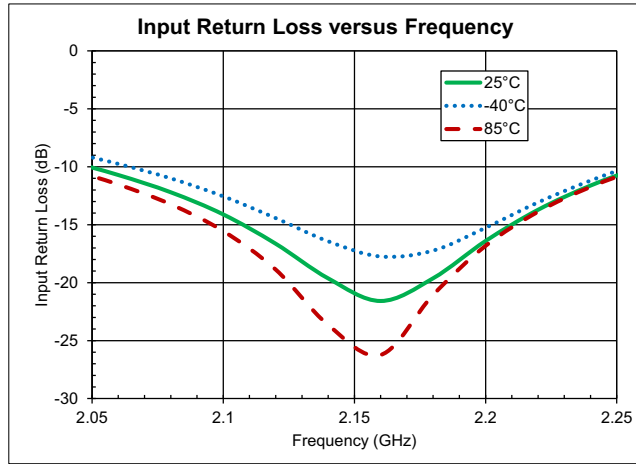
## Evaluation Board Assembly Drawing 728MHz to 768MHz Application Circuit





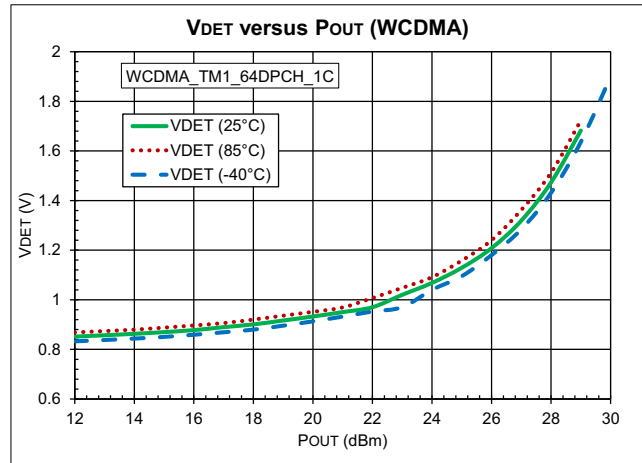
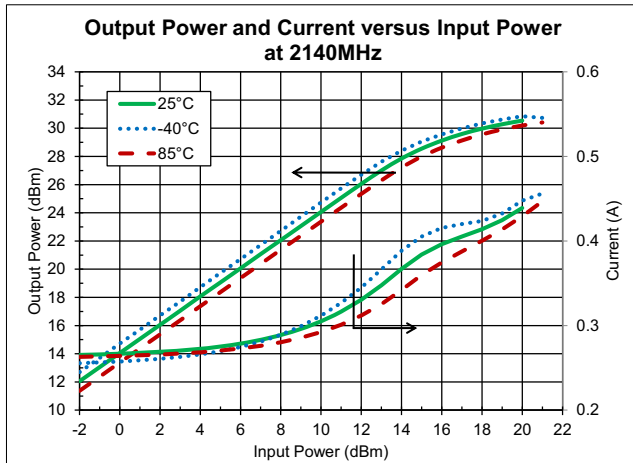
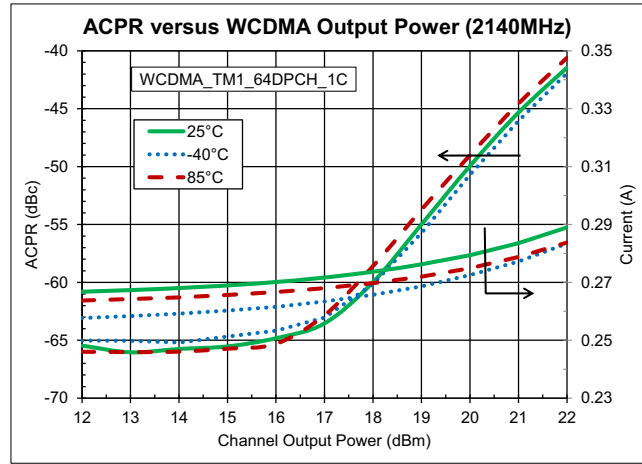
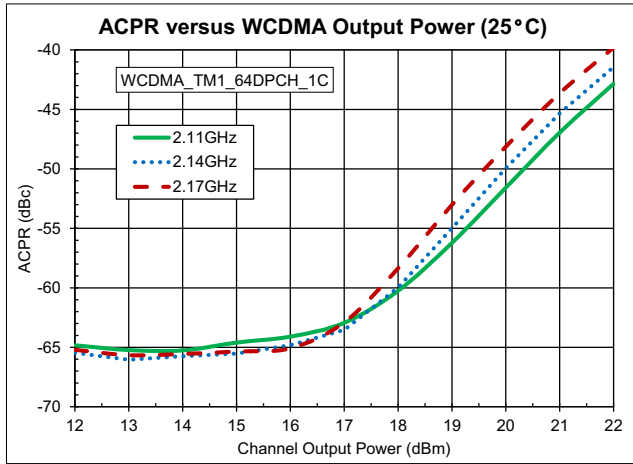
Typical Performance:  $V_{CC} = V_{BIAS} = V_{REG} = 5V$

2.11GHz to 2.17GHz Application Circuit



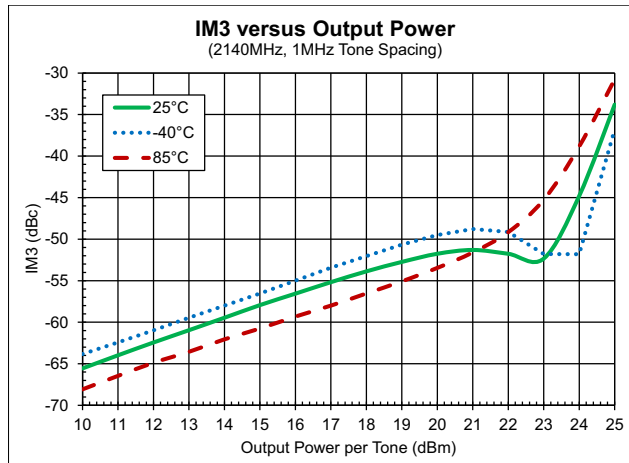
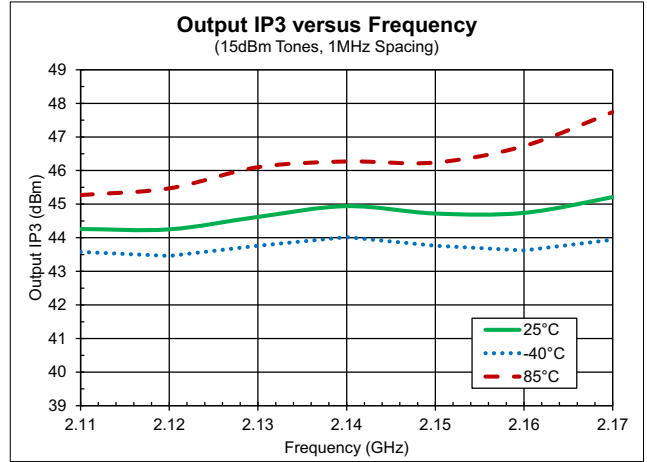
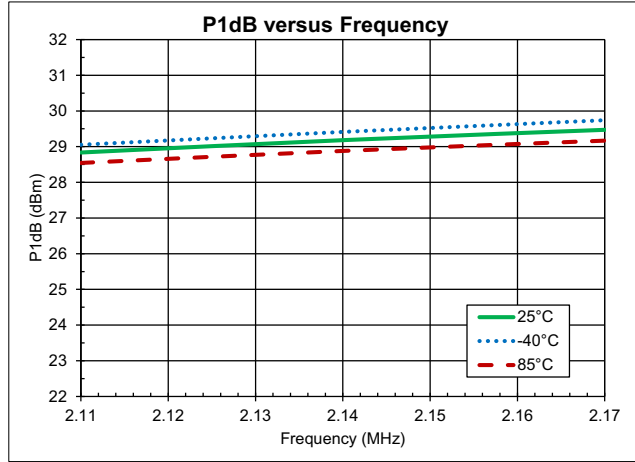
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### 2.11GHz to 2.17GHz Application Circuit

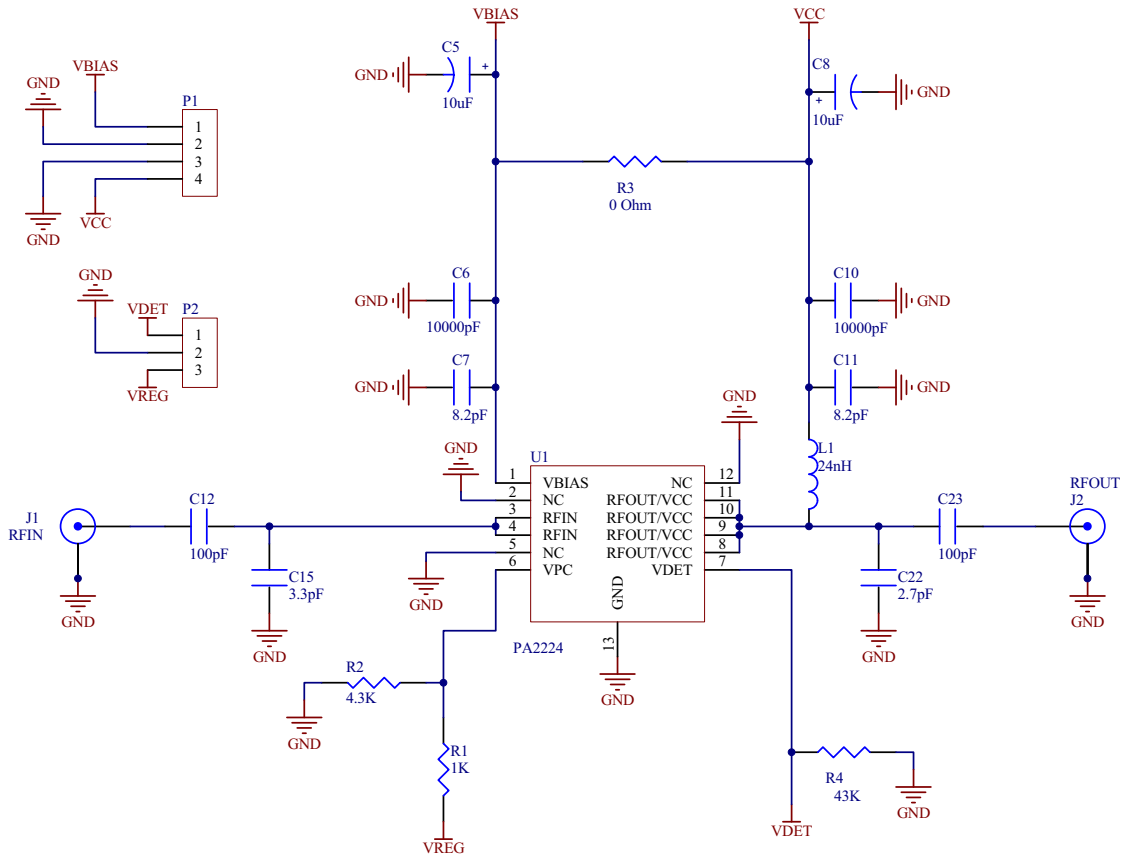


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2.11GHz to 2.17GHz Application Circuit



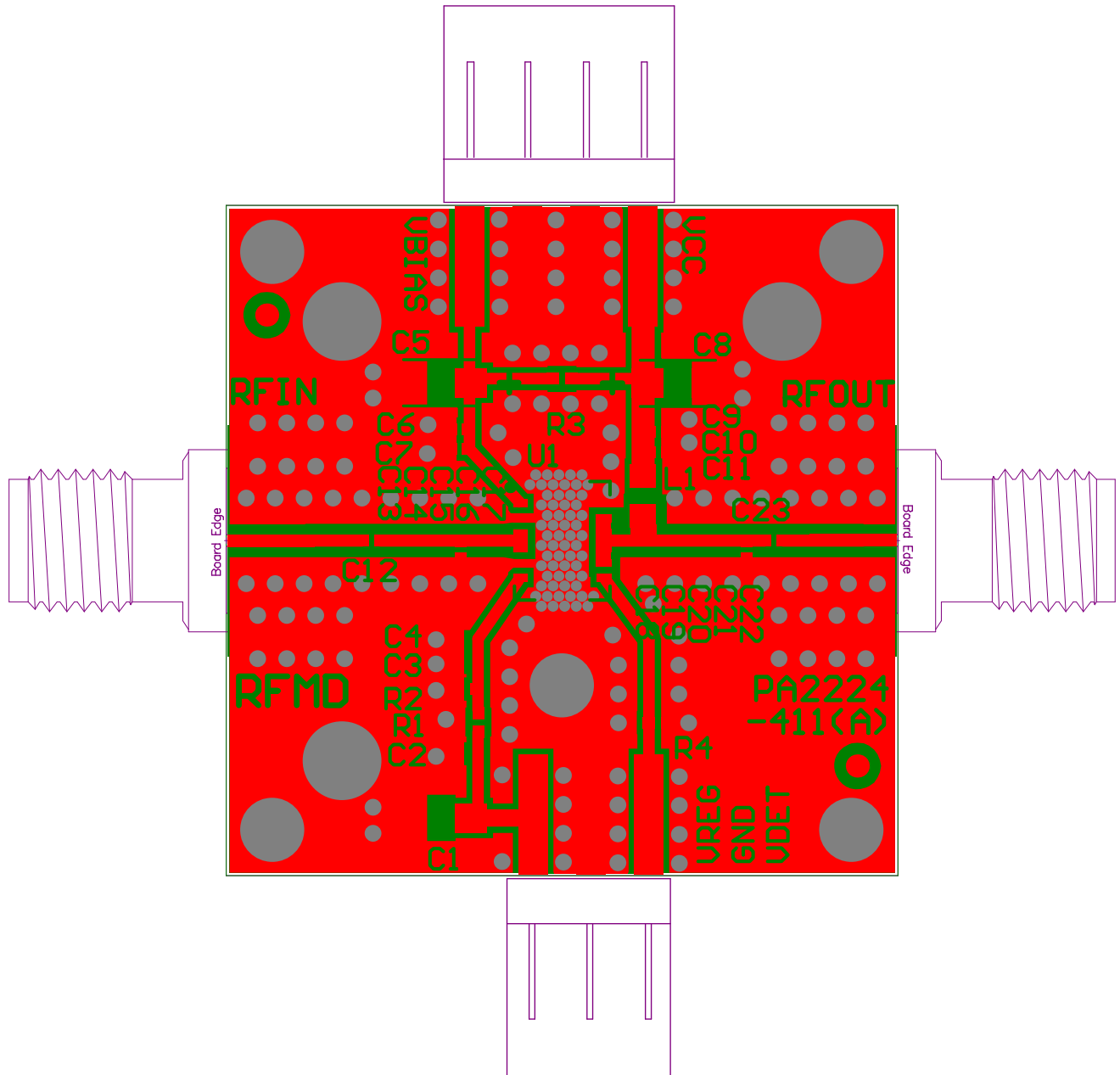
## Evaluation Board Schematic 2.11GHz to 2.17GHz Application Circuit



## Evaluation Board Bill of Materials (BOM) 2.11GHz to 2.17GHz Application Circuit

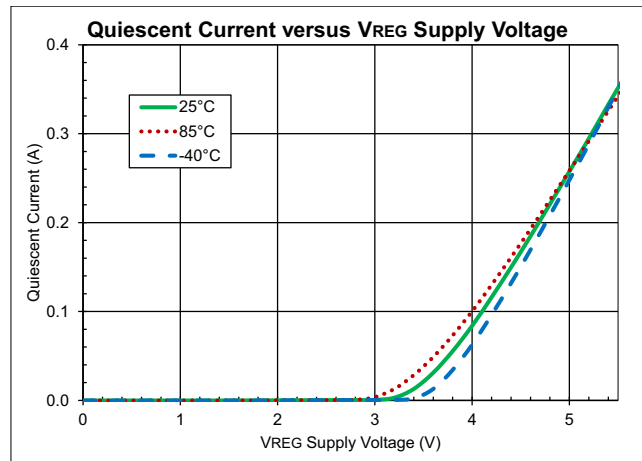
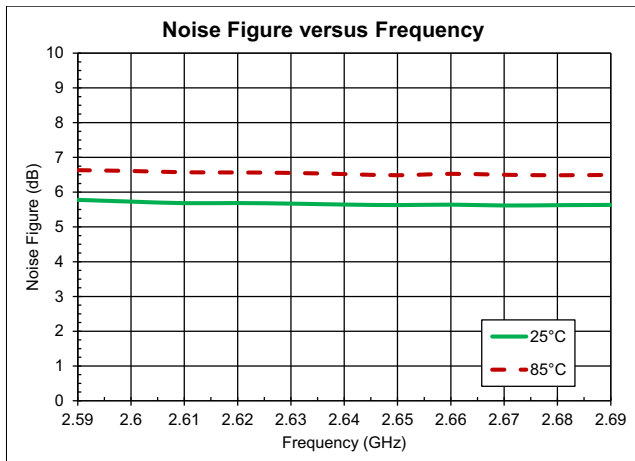
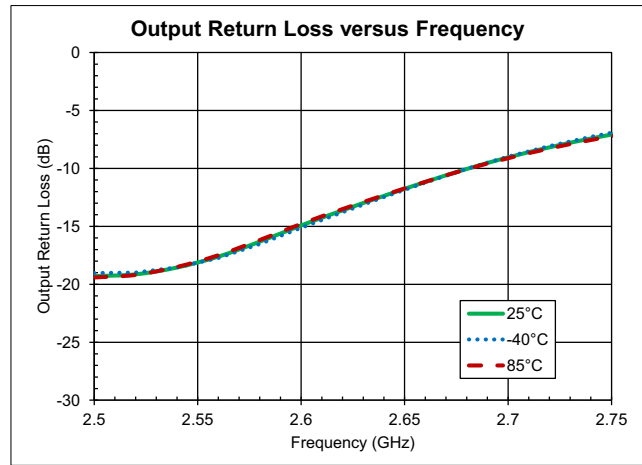
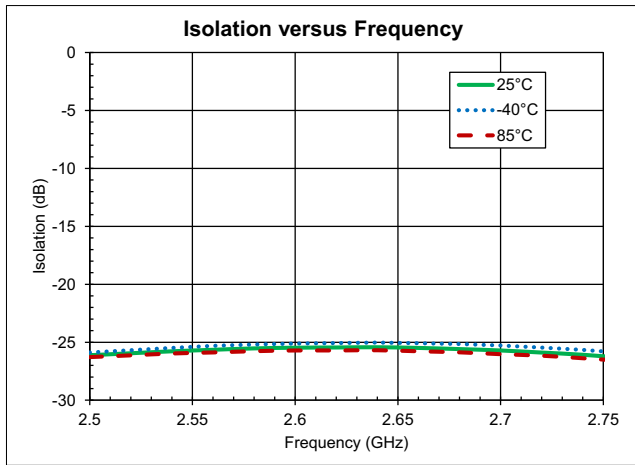
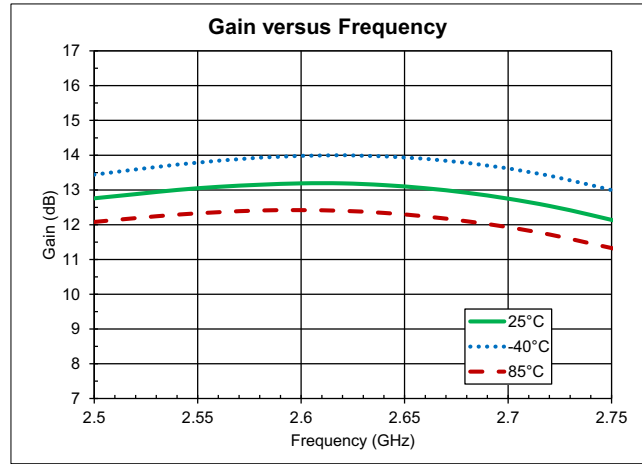
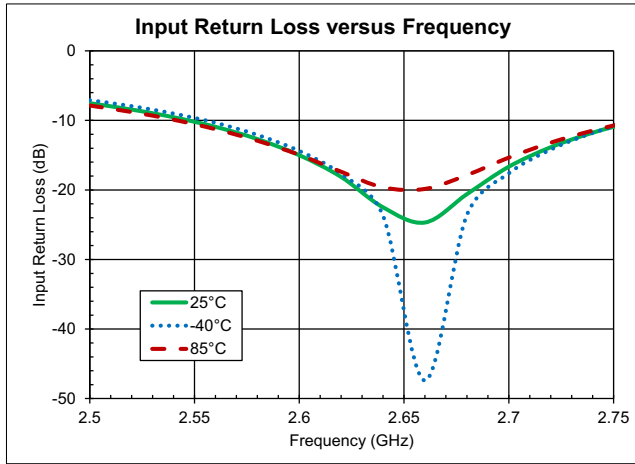
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400MHz to 2700MHz, 1W, 5V High Gain Linear PA	U1	RFMD	PA2224
CAP, 10 $\mu$ F, 10%, 10V, TANT-A	C5, C8	AVX Corporation	TAJA106K010R
CAP, 10000pF, 10%, 16V, X7R, 0402	C6, C10	Taiyo Yuden (USA), Inc.	RM EMK105BJ103KV-F
CAP, 8.2pF, +/-0.5pF, 50V, COG, 0402	C7,C11	Taiyo Yuden (USA), Inc.	RM UMK105 CG8R2DV-F
CAP, 100pF, 5%, 50V, COG, 0402	C12, C23	Murata Electronics	GRM1555C1H101JA01D
CAP, 3.3pF, +/-0.1pF, 50V, HI-Q, 0402	C15	Johanson Technology	500R07S3R3BV4T
CAP, 2.7pF, +/-0.1pF, 50V, HI-Q, 0402	C22	Johanson Technology	500R07S2R7BV4TD
CONN, SMA, END LNCH, RND PIN, 0.039"	J1-J2	Gigalane Co., Ltd.	PSF-S01-002
IND, 24nH, 5%, W/W, 0603	L1	Coilcraft, Inc.	0603HC-24NXJLW
CONN, HDR, ST, PLRZD, 4-PIN, 0.100"	P1	ITW Pancon	MPSS100-4-C
CONN, HDR, ST, PLRZD, 3-PIN, 0.100"	P2	ITW Pancon	MPSS100-3-C
RES, 1K, 5%, 1/16W, 0402	R1	Kamaya, Inc	RMC1/16S-102JTH
4.3K $\Omega$ , 5%, 1/16W, 0402, LEAD FREE	R2	KOA Speer Electronics, Inc.	RK73B1ETTP432J
RES, 0 $\Omega$ , 0402	R3	Kamaya, Inc	RMC1/16SJPTH
RES, 43K, 5%, 1/16W, 0402	R4	Kamaya, Inc	RMC1/16S-433JTH

**Evaluation Board Assembly Drawing**  
2.11GHz to 2.17GHz Application Circuit



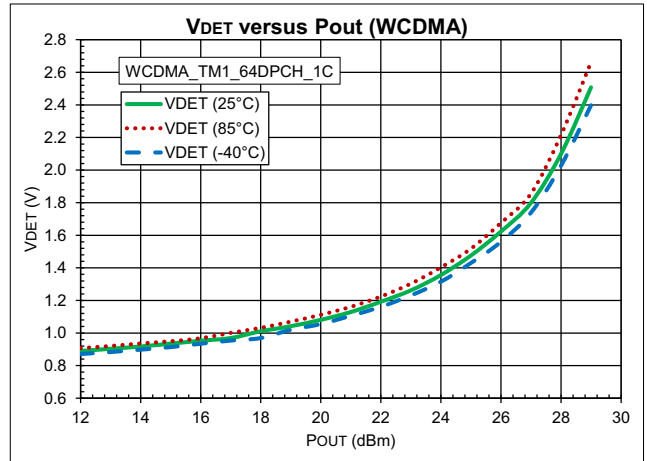
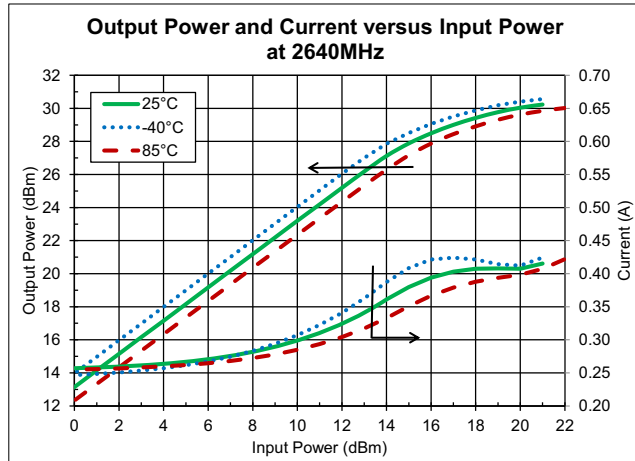
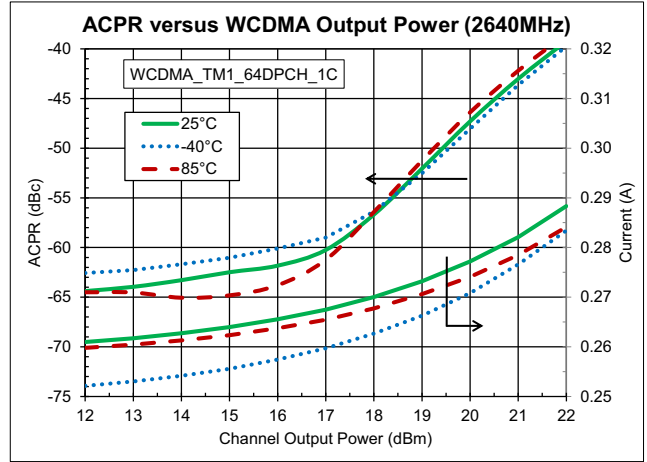
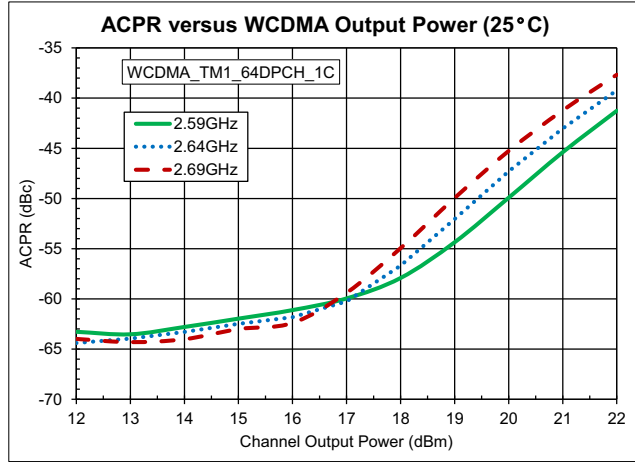
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2.58GHz to 2.69GHz Application Circuit



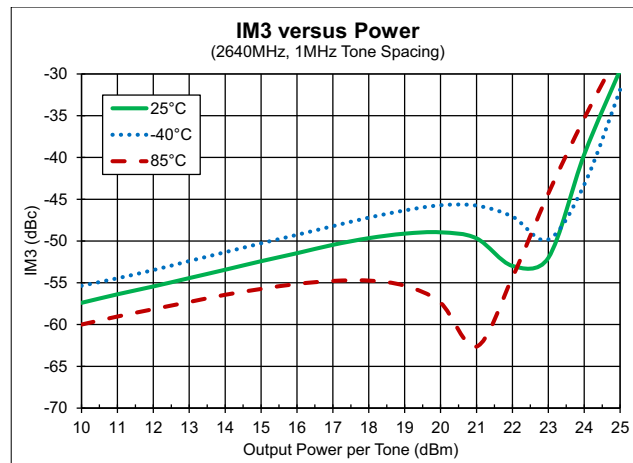
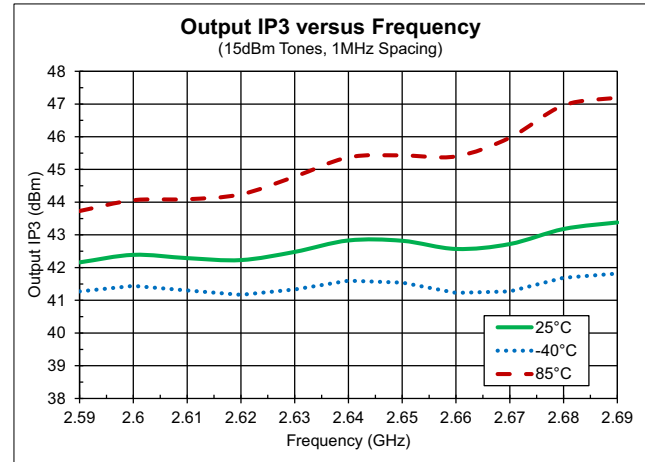
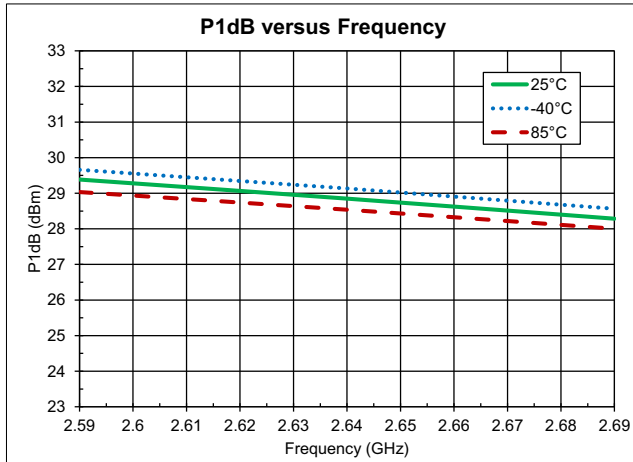
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2.58GHz to 2.69GHz Application Circuit



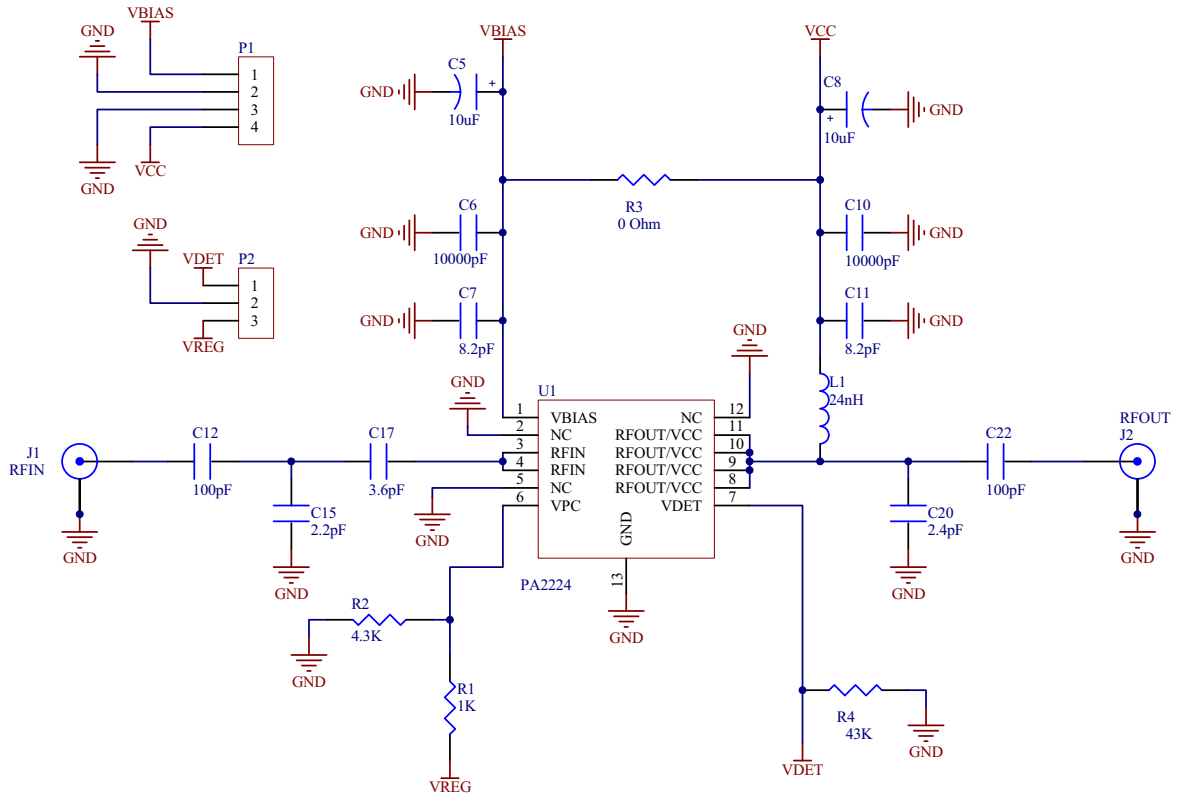
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2.58GHz to 2.69GHz Application Circuit





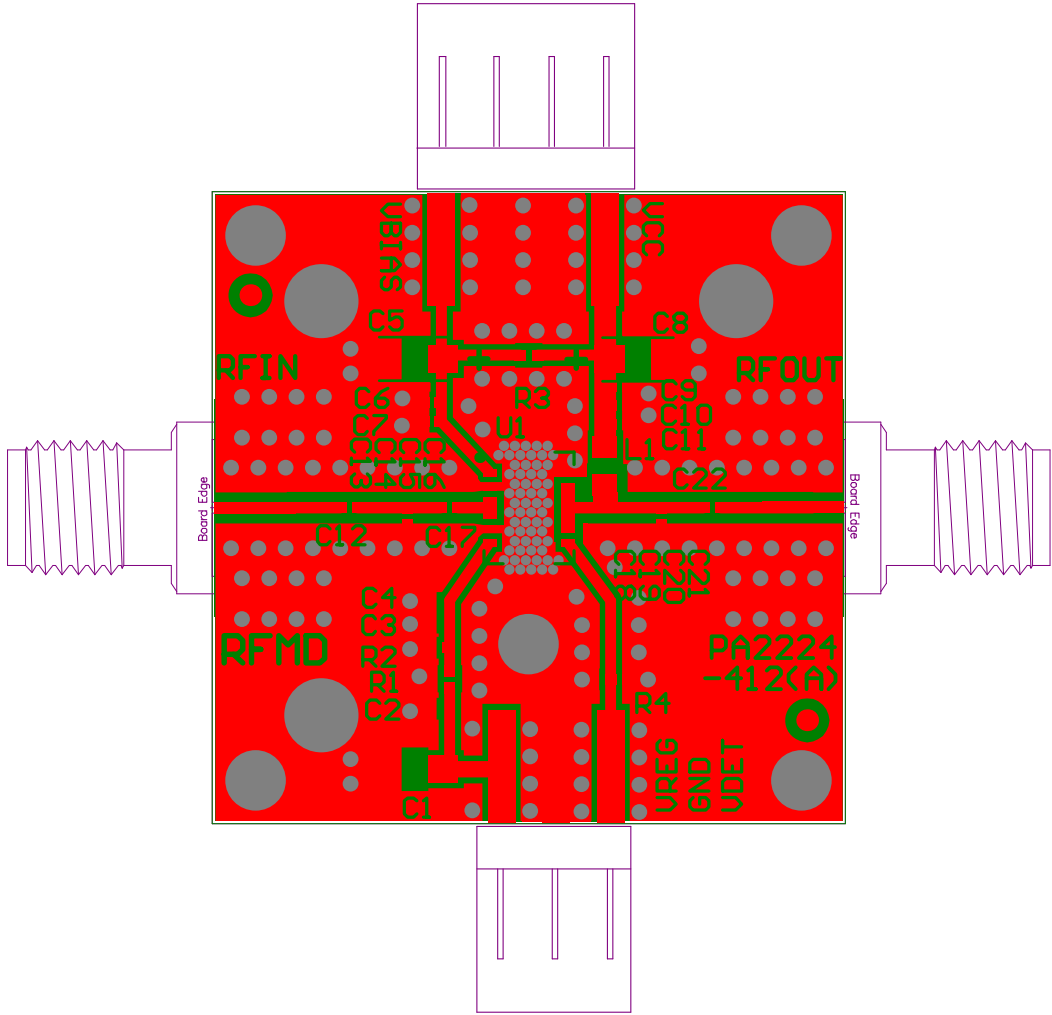
## Evaluation Board Schematic 2.58GHz to 2.69GHz Application Circuit



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CAP, 10000pF, 10%, 16V, X7R, 0402	C6, C10	Taiyo Yuden (USA), Inc.	RM EMK105BJ103KV-F
CAP, 8.2pF, +/-0.5pF, 50V, C0G, 0402	C7, C11	Taiyo Yuden (USA), Inc.	RM UMK105 CG8R2DV-F
CAP, 100pF, 5%, 50V, C0G, 0402	C12, C22	Murata Electronics	GRM1555C1H101JA01D
CAP, 2.2pF, +/-0.1pF, 50V, HI-Q, 0402	C15	Johanson Technology	500R07S2R2BV4TD
CAP, 3.6pF, +/-0.1pF, 50V, HI-Q, 0402	C17	Johanson Technology	500R07S3R6BV4TD
CAP, 2.4pF, +/-0.1pF, 50V, HI-Q, 0402	C20	Johanson Technology	500R07S2R4BV4TD
CONN, SMA, END LNCH, RND PIN, 0.039"	J1-J2	Gigalane Co., Ltd.	PSF-S01-002
IND, 24nH, 5%, W/W, 0603	L1	Coilcraft, Inc.	0603HC-24NXJLW
CONN, HDR, ST, PLRZD, 4-PIN, 0.100"	P1	ITW Pancon	MPSS100-4-C
CONN, HDR, ST, PLRZD, 3-PIN, 0.100"	P2	ITW Pancon	MPSS100-3-C
RES, 1K, 5%, 1/16W, 0402	R1	Kamaya, Inc	RMC1/16S-102JTH
4.3KΩ, 5%, 1/16W, 0402, LEAD FREE	R2	KOA Speer Electronics, Inc.	RK73B1ETTP432J
RES, 0Ω, 0402	R3	Kamaya, Inc	RMC1/16SJPTH
RES, 43K, 5%, 1/16W, 0402	R4	Kamaya, Inc	RMC1/16S-433JTH

## Evaluation Board Assembly Drawing 2.58GHz to 2.69GHz Application Circuit



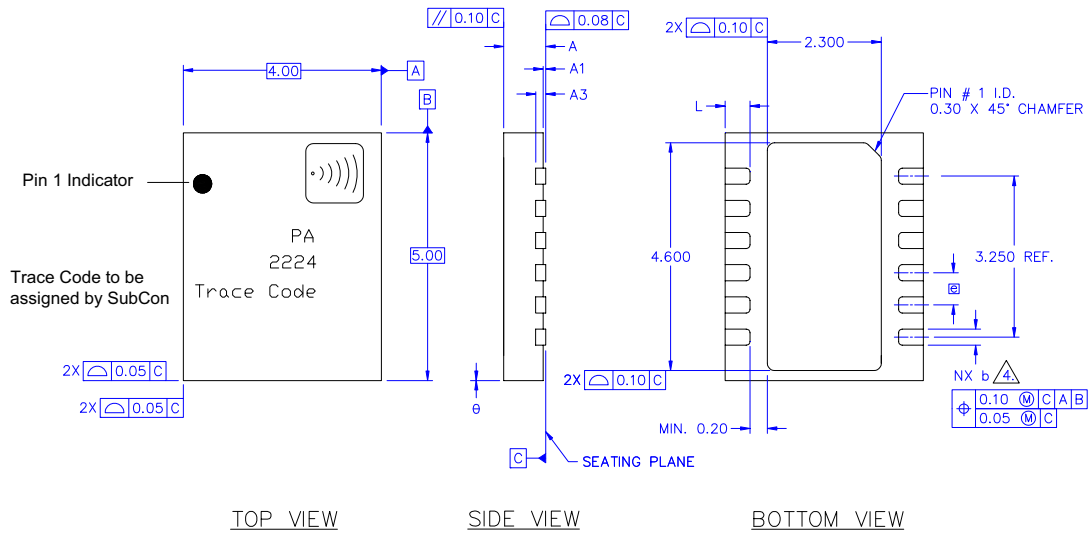
## Pin Names and Description

Pin	Name	Description
1	VBIAS	V <sub>CC</sub> supply to active bias circuit
2	NC	No internal connection
3	RFIN	RF input, must be DC blocked
4	RFIN	RF input, must be DC blocked
5	NC	No internal connection
6	VREG	Current adjust/shutdown control
7	VDET	Power detector output voltage. Detector samples the input power.
8	NC	No internal connection
9	RFOUT/VCC	RF output and collector supply
10	RFOUT/VCC	RF output and collector supply
11	NC	No internal connection
12	NC	No internal connection
EPAD	GND	DC and RF Ground. Must be soldered to EVB ground plane over a bed of vias for thermal and RF performance. Solder/epoxy voids under the EPAD will result in excessive junction temperatures causing permanent damage.

## Package and Branding Diagram

Dimensions in millimeters

Refer to drawing posted at [www.rfmd.com](http://www.rfmd.com) for tolerances.



Symbol	COMMON DIMENSIONS		
	MIN.	NOM.	MAX.
A	0.80	0.85	0.90
A1	0.00	0.02	0.05
A3	0.20 REF.		
θ	0	-	12°
e	0.65 BSC		
N	12		
L	0.45	0.50	0.55
b	0.275	0.325	0.375